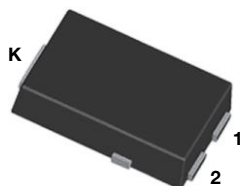


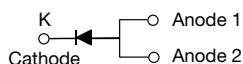
# High Current Density Surface Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low  $V_F = 0.28\text{ V}$  at  $I_F = 5\text{ A}$

## eSMP® Series



## SMPC (TO-277A)



## LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS                                |                |
|--------------------------------------------------------|----------------|
| $I_{F(AV)}$                                            | 15 A           |
| $V_{RRM}$                                              | 50 V           |
| $I_{FSM}$                                              | 200 A          |
| $V_F$ at $I_F = 15\text{ A}$ ( $T_A = 125\text{ °C}$ ) | 0.40 V         |
| $T_J$ max.                                             | 150 °C         |
| Package                                                | SMPC (TO-277A) |
| Circuit configuration                                  | Single         |

## FEATURES

- Very low profile - typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

## TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling, and polarity protection applications.

## MECHANICAL DATA

### Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test

## MAXIMUM RATINGS ( $T_A = 25\text{ °C}$ unless otherwise noted)

| PARAMETER                                                                          | SYMBOL         | V15PL50     | UNIT |
|------------------------------------------------------------------------------------|----------------|-------------|------|
| Device marking code                                                                |                | 15L5        |      |
| Maximum repetitive peak reverse voltage                                            | $V_{RRM}$      | 50          | V    |
| Maximum average forward rectified current (fig. 1)                                 | $I_F^{(1)}$    | 15          | A    |
|                                                                                    | $I_F^{(2)}$    | 6.0         |      |
| Maximum DC reverse voltage                                                         | $V_{DC}$       | 35          | V    |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | $I_{FSM}$      | 200         | A    |
| Operating junction and storage temperature range                                   | $T_J, T_{STG}$ | -40 to +150 | °C   |

## Notes

(1) Mounted on 30 mm x 30 mm pad areas aluminum PCB

(2) Free air, mounted on recommended copper pad area



| ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted) |                        |                         |                               |      |      |      |
|----------------------------------------------------------------------------|------------------------|-------------------------|-------------------------------|------|------|------|
| PARAMETER                                                                  | TEST CONDITIONS        |                         | SYMBOL                        | TYP. | MAX. | UNIT |
| Instantaneous forward voltage                                              | I <sub>F</sub> = 5.0 A | T <sub>A</sub> = 25 °C  | V <sub>F</sub> <sup>(1)</sup> | 0.40 | -    | V    |
|                                                                            | I <sub>F</sub> = 7.5 A |                         |                               | 0.42 | -    |      |
|                                                                            | I <sub>F</sub> = 15 A  |                         |                               | 0.49 | 0.57 |      |
|                                                                            | I <sub>F</sub> = 5.0 A | T <sub>A</sub> = 125 °C |                               | 0.28 | -    |      |
|                                                                            | I <sub>F</sub> = 7.5 A |                         |                               | 0.31 | -    |      |
|                                                                            | I <sub>F</sub> = 15 A  |                         |                               | 0.40 | 0.48 |      |
| Reverse current                                                            | V <sub>R</sub> = 35 V  | T <sub>A</sub> = 25 °C  | I <sub>R</sub> <sup>(2)</sup> | 35   | -    | μA   |
|                                                                            |                        | T <sub>A</sub> = 125 °C |                               | 20   | -    | mA   |
|                                                                            | V <sub>R</sub> = 50 V  | T <sub>A</sub> = 25 °C  |                               | -    | 800  | μA   |
|                                                                            |                        | T <sub>A</sub> = 125 °C |                               | 35   | 80   | mA   |

**Notes**(1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle(2) Pulse test: Pulse width  $\leq 5\text{ ms}$ 

| THERMAL CHARACTERISTICS ( $T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted) |                          |         |                      |
|--------------------------------------------------------------------------------------|--------------------------|---------|----------------------|
| PARAMETER                                                                            | SYMBOL                   | V15PL50 | UNIT                 |
| Typical thermal resistance                                                           | $R_{\theta JA}^{(1)(2)}$ | 70      | $^{\circ}\text{C/W}$ |
|                                                                                      | $R_{\theta JM}^{(3)}$    | 4       |                      |

**Notes**(1) Free air, mounted on recommended copper pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient(2) The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ (3) Mounted on 30 mm x 30 mm 2 oz. pad PCB; thermal resistance  $R_{\theta JM}$  - junction to mount measured at cathode side

| ORDERING INFORMATION (Example) |                 |                        |               |                                    |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|
| PREFERRED P/N                  | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                      |
| V15PL50-M3/86A                 | 0.10            | 86A                    | 1500          | 7" diameter plastic tape and reel  |
| V15PL50-M3/87A                 | 0.10            | 87A                    | 6500          | 13" diameter plastic tape and reel |

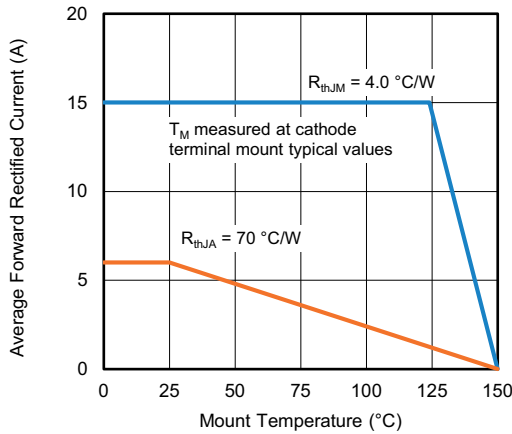
**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)


Fig. 1 - Maximum Forward Current Derating Curve

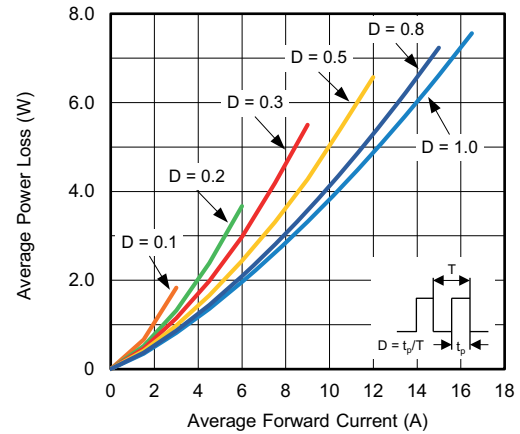


Fig. 2 - Forward Power Loss Characteristics

**Notes**

- (1) Mounted on 30 mm x 30 mm aluminum PCB;  $T_M$  measured at the terminal of cathode band ( $R_{\theta JM} = 4\text{ }^{\circ}\text{C/W}$ )
- (2) Free air, mounted on recommended copper pad area ( $R_{\theta JA} = 70\text{ }^{\circ}\text{C/W}$ )

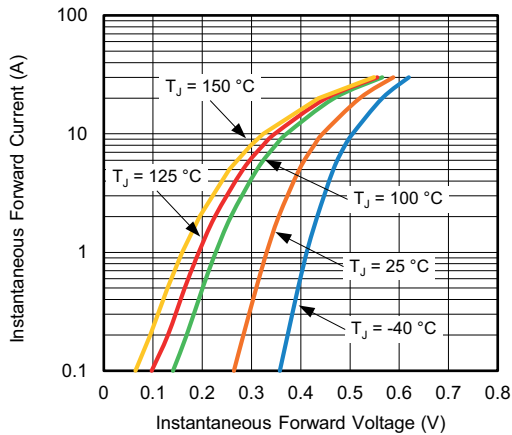


Fig. 3 - Typical Instantaneous Forward Characteristics

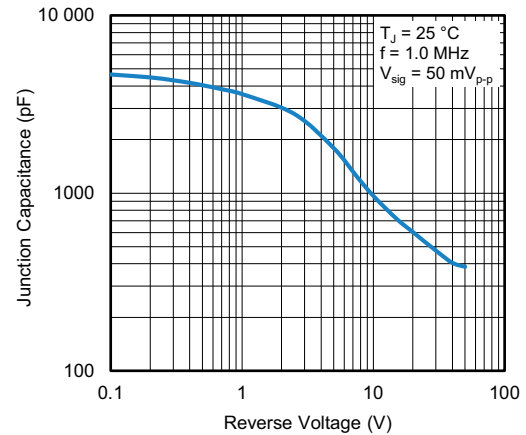


Fig. 5 - Typical Junction Capacitance

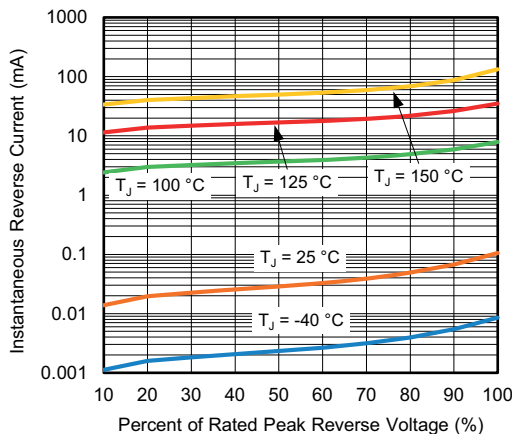


Fig. 4 - Typical Reverse Leakage Characteristics

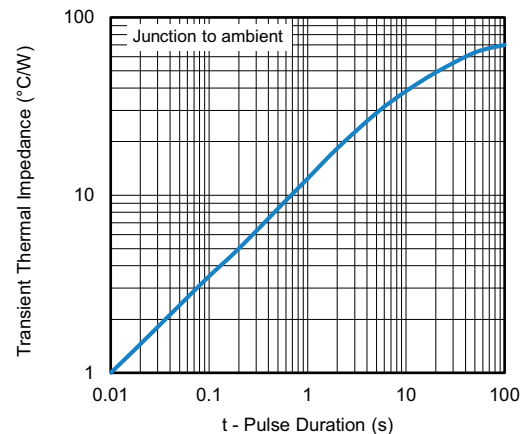
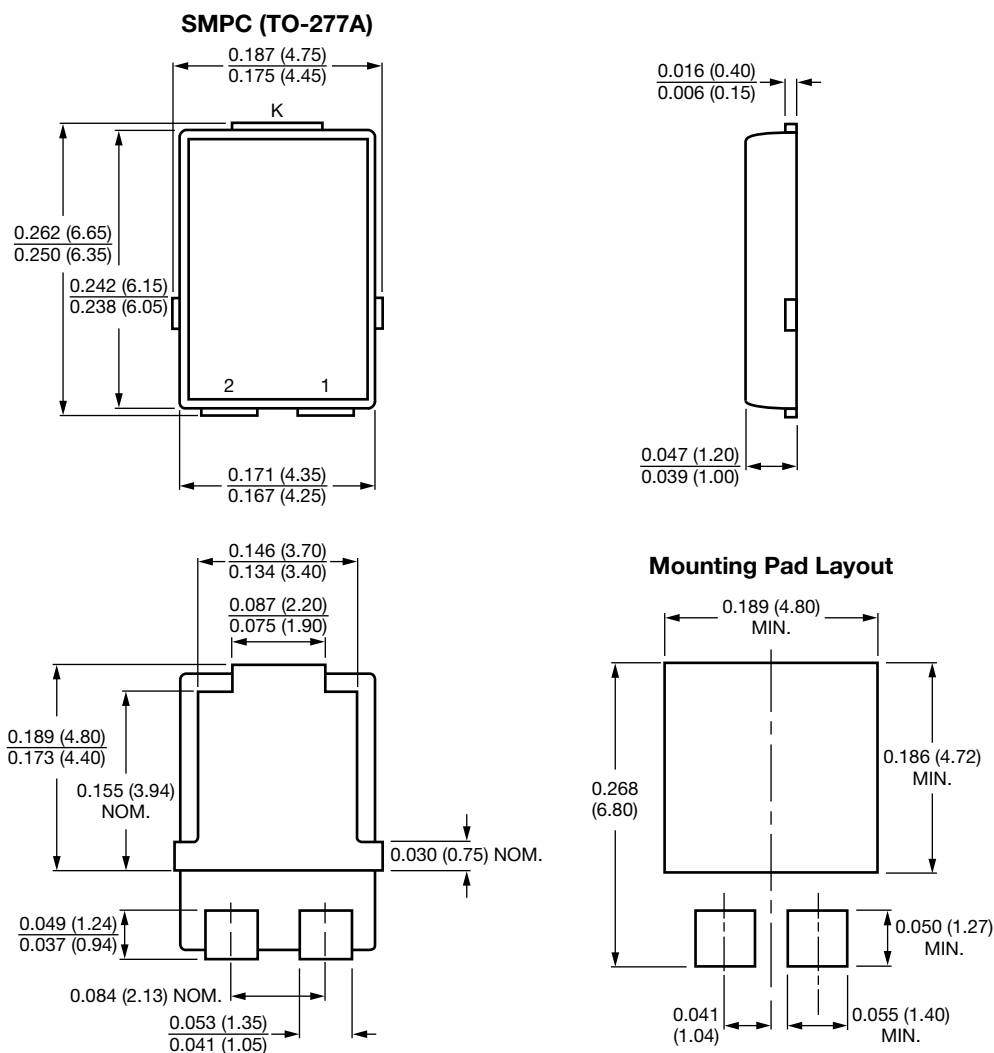


Fig. 6 - Typical Transient Thermal Impedance

**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)


Conform to JEDEC® TO-277A



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